

**Product data sheet** 

# 1. Product profile

### **1.1 General description**

The BB207 is a variable capacitance double diode with a common cathode, fabricated in silicon planar technology, and encapsulated in the SOT23 small plastic SMD package.

### 1.2 Features and benefits

- Excellent linearity
- C<sub>d(1V)</sub>: 81 pF; C<sub>d(7.5V)</sub>: 27.6 pF
- C<sub>d(1V)</sub> to C<sub>d(7.5V)</sub> ratio: min. 2.6
- Very low series resistance
- Small plastic SMD package.

## **1.3 Applications**

Electronic tuning in FM-radio.

# 2. Pinning information

Pin	Description	Simplified outline	Symbol
1	anode 1	_	
2	anode 2		3
3	common cathode		

3. Ordering information

Table 2.         Ordering information						
Type number	Package	je				
	Name	Description	Version			
BB207	-	plastic surface mounted package; 3 leads	SOT23			



sym032

#### Marking 4.

Table 3. Markin	
Type number	Marking code <sup>[1]</sup>
BB207	*13

[1] \* = p: made in Hong Kong. \* = w: made in China.

#### **Limiting values** 5.

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V <sub>R</sub>	continuous reverse voltage		-	15	V
I <sub>F</sub>	continuous forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

#### **Characteristics** 6.

#### **Electrical Characteristics** Table 5.

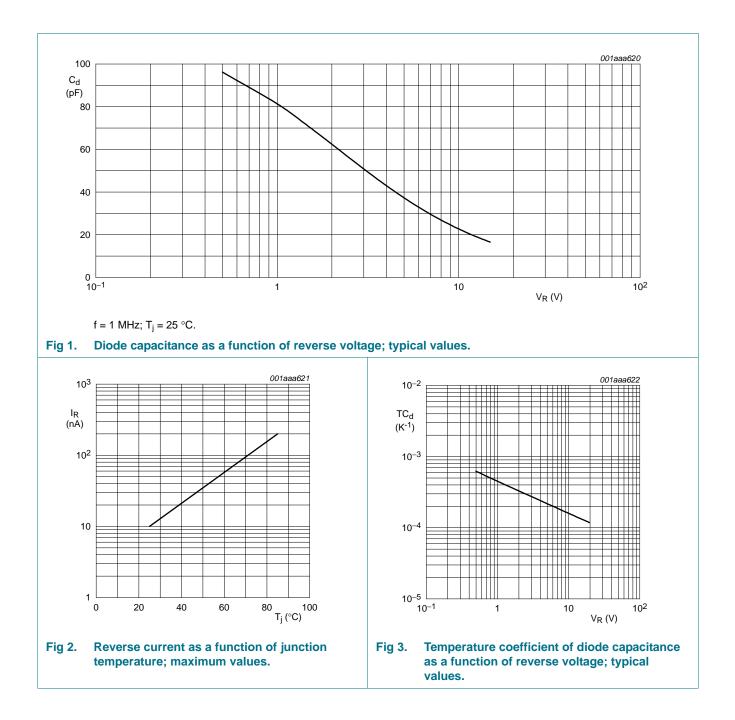
 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per diode						
I <sub>R</sub>	reverse current	V <sub>R</sub> = 15 V; see <u>Figure 2</u>	-	_	10	nA
		$V_R$ = 15 V; $T_j$ = 85 °C; see <u>Figure 2</u>	-	_	200	nA
r <sub>s</sub>	diode series resistance	f = 100 MHz; V <sub>R</sub> = 3 V	-	0.2	0.4	Ω
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; see <u>Figure 1</u>	76	81	86	pF
		$V_R = 3 V$ ; f = 1 MHz; see Figure 1	-	50.5	-	pF
		$V_R = 7.5 V$ ; f = 1 MHz; see Figure 1	25.5	27.6	29.7	pF
		$V_R = 8 V; f = 1 MHz; see Figure 1$	-	26.3	-	pF
$\frac{C_{d(1V)}}{C_{1/7,5V}}$	capacitance ratio	f = 1 MHz	2.6	_	3.3	

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# FM variable capacitance double diode

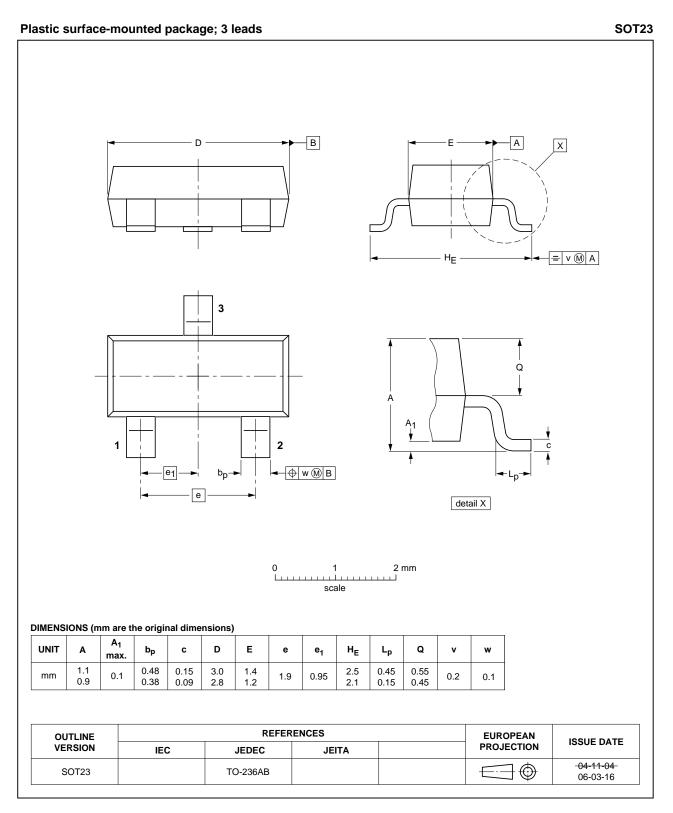
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# 7. Package outline



#### Fig 4. Package outline.

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BB207

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# 8. Revision history

Table 6. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB207 v.3	20110907	Product data sheet	-	BB207 v.2
Modifications:		t of this data sheet has bee of NXP Semiconductors.	en redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	s have been adapted to the	new company name whe	ere appropriate.
	<ul> <li>Package d</li> </ul>	outline drawings have been	updated to the latest vers	sion.
BB207 v.2 (9397 750 13003)	20040427	Product data	-	BB207_N v.1
BB207_N v.1 (9397 750 12695)	20031117	Preliminary data	-	-

# 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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